#### **DECLARATION**

I, Takako Hosoi, c/o YAMADA PATENT OFFICE of The Tanabe Bldg., 6-6, Fushimimachi 2-chome, Chuo-ku, Osaka-shi, Osaka, Japan, declare that I am the translator of the documents attached, which are to the best of my knowledge and belief a true and correct translation of International Application No. PCT/JP03/11279.

DATE: March 1, 2005

Signature of translator

Takako Hosoi

# Rec'd PCT/PTO 07 MAR 2005

10/526897

Armstrong, Kratz, Quintos, Hanson & Brooks, LLP

### **DECLARATION FOR U.S. PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

(Number) (Country) (Day/Month/Year Filed)  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior foreign applications  (See note B) See attached list for additional prior for	DATA D	DOCESSING ADDADATUS			
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Was filed on   SEPTEMBER 3, 2003 as United States Application Number or PCT International Application Number   PCT/IP03/11279   and was amended on					
Application Number PCT/IP03/11279 and was amended on	the specificati	on of which is attached hereto ur	nless the following is ch	ecked	
In hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above.  I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.  I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) – (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.  (List prior foreign applications. See    2002-263768	was filed o	on SEPTEMBER 3, 2003 as Ur	ited States Application	Number or PCT International	
claim(s), as amended by any amendment referred above.  I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.  I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) – (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.    Clust prior foreign   Priority Claimed   Priority Cl	Application	n Number <u>PCT/JP03/11279</u> and	was amended on	(if applicable).	
Regulations, § 1.56.  I hereby claim for patent of (Country)   (Country)   (Day/Month/Year Filed)   Yes   No (Number)   (Country)   (Day/Month/Year Filed)   Yes   No (Number)   Country)   (Day/Month/Year Filed)   Yes   No (Number)   Country)   (Day/Month/Year Filed)   Yes   No (See note B)   See attached list for additional prior foreign applications of this application is not disclosed in the prior United States application.    Applications Serial No.)   (Filing Date)   Patented   Pending   Abandoned   Pending   Pending   Abandoned   Pending   P				above-identified specification,	including the
for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.    Clast prior foreign applications. See   2002-263768   Japan   10/September/2002   Yes   No   No   (Number)   (Country)   (Day/Month/Year Filed)   Yes   No   (Number)   (Numb			which is material to pa	tentability as defined in Title	37, Code of Federal
(List prior foreign applications. See note A)    Country   Country	for patent or in	nventor's certificate listed below	and have also identified	d below any foreign applicatio	n for patent or
Applications   See   2002-263768   Japan   10/September/2002   Yes   No			e that of the application	for which priority is claimed.	
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(Number) (Country) (Day/Month/Year Filed)    Yes   No	note A)	(Number)			
Yes   No   No   (Number)   (Country)   (Day/Month/Year Filed)   Yes   No   (Number)   (Day/Month/Year Filed)   Yes   No   (Number)   (Day/Month/Year Filed)   Yes   No   (Number)   (Day/Month/Year Filed)   Yes   No   (Day/Month/Year Filed)   Yes   No   (Day/Month/Year Filed)   (Day/Month/Year Filed)   Yes   No   (Number)   No   (Number)   (Numb					☐ Yes ☐ No
(Number) (Country) (Day/Month/Year Filed)  (Number) (Country) (Day/Month/Year Filed)  (See note B) See attached list for additional prior foreign applications  (I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, nsofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.  Status  (Application Serial No.) (Filing Date)  Patented Pending Abandoned  (Application Serial No.) (Filing Date)		(Number)	(Country)	(Day/Month/Year Filed)	
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(Application Serial No.) (Filing Date)		(Application Serial No.)	(Filing Date)	Patented Pend	ing 🗌 Abandoned

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

## 23850

Please direct all communications to the following address:

## 23850 PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, ' 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Pacidence Citizenship	note C)	Full name of sole or fin	rst inventor (given name, family name)	Junya KAKU	
Post Office Address  804, 2-1-11, Miyanomae, Itami-shi, Hyogo 664-0895 Japan  Full name of second inventor (given name, family name) Inventor's signature Post Office Address  Full name of third inventor (given name, family name) Inventor's signature Residence Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature Residence Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature Residence Post Office Address	, _U <sup>U</sup>	Inventor's signature	Junya Kaku		uary 25, 2005
Full name of second inventor (given name, family name) Inventor's signature  Residence Post Office Address  Full name of third inventor (given name, family name) Inventor's signature Residence Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature Residence Post Office Address  Full name of fourth inventor (given name; family name) Inventor's signature Residence Citizenship  Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature Residence Post Office Address	1-		Hyogo, Japan JPV	Citizenship ———	Chinese
Inventor's signature  Residence  Citizenship  Post Office Address  Full name of third inventor (given name, family name) Inventor's signature  Residence  Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature  Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature  Residence  Post Office Address  Full name of fifth inventor (given name, family name)  Full name of fifth inventor (given name, family name)		Post Office Address	804, 2-1-11, Miyanomae, Itami-shi, Hy	ogo 664-0895 Japan	1
Inventor's signature  Residence  Citizenship  Post Office Address  Full name of third inventor (given name, family name) Inventor's signature  Residence  Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature  Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature  Residence  Citizenship  Post Office Address  Full name of fifth inventor (given name, family name)  Full name of fifth inventor (given name, family name)		-			
Inventor's signature  Residence  Citizenship  Post Office Address  Full name of third inventor (given name, family name) Inventor's signature  Residence  Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature  Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature  Residence  Citizenship  Post Office Address  Full name of fifth inventor (given name, family name)		-		Photo Photo	
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Full name of third inventor (given name, family name) Inventor's signature  Residence  Post Office Address  Full name of fourth inventor (given name, family name) Inventor's signature  Residence  Citizenship  Date  Citizenship  Post Office Address  Full name of fifth inventor (given name, family name)  Full name of fifth inventor (given name, family name)				Citizenship	
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Residence Citizenship  Post Office Address  Full name of fifth inventor (given name, family name)		Full name of fourth inv	entor (given name; family name)		
Post Office Address  Full name of fifth inventor (given name, family name)		Inventor's signature			
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#### **NOTES**

- A. Please list all foreign applications relating to the invention and check block, "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.